

L Number	Hits	Search Text	DB	Time stamp
-	130001	((printed\$ or wiring or circuit) near4 board)	USPAT	2004/01/13 08:39
-	128023	((printed\$ or wiring or circuit) near4 board) and (one or one-5 or single\$)	USPAT	2004/01/12 17:59
-	36695	((printed\$ or wiring or circuit) near4 board) and (one or one-5 or single\$) adj (side)	USPAT	2004/01/12 18:00
-	1679	((printed\$ or wiring or circuit) near4 board) and (one or one-5 or single\$) adj (side) and warp\$	USPAT	2004/01/12 18:00
-	34	((printed\$ or wiring or circuit) near4 board) and (one or one-5 or single\$) adj (side) and warp\$ and (paper\$) same (phenol\$)	USPAT	2004/01/13 09:32
-	0	"20020110697"	USPAT	2004/01/13 08:37
-	1	"20020110697"	USPAT; US-PGFWB	2004/01/13 08:37
-	130229	((printed\$ or wiring or circuit) near4 board)	USPAT	2004/01/13 10:17
-	647	((printed\$ or wiring or circuit) near4 board) and (resist\$ or photoresist\$) same warp\$	USPAT	2004/01/13 09:12
-	159	((printed\$ or wiring or circuit) near4 board) and (balanc\$) same warp\$	USPAT	2004/01/13 09:12
-	87	((printed\$ or wiring or circuit) near4 board) and (balanc\$) near10 warp\$	USPAT	2004/01/13 11:09
-	212	((printed\$ or wiring or circuit) near4 board) and ((one or single\$) adj (side\$)) same warp\$	USPAT	2004/01/13 12:02
-	232310	((printed\$ or wiring or circuit) near4 board)	EPO; JPO; DERNMENT	2004/01/13 10:17
-	2273	((printed\$ or wiring or circuit) near4 board) and warp\$	EPO; JPO; DERNMENT	2004/01/13 10:17
-	144	((printed\$ or wiring or circuit) near4 board) and warp\$ and (single or one) adj (side\$)	EPO; JPO; DERNMENT	2004/01/13 10:18
-	72	((printed\$ or wiring or circuit) near4 board) and (balanc\$) same warp\$ not (((printed\$ or wiring or circuit) near4 board) and (balanc\$) near10 warp\$)	USPAT	2004/01/13 11:09
-	355	((printed\$ or wiring or circuit) near4 board) and warp\$.ab.	USPAT	2004/01/13 12:05
-	1940	(428/901).CCL\$.	USPAT	2004/01/14 16:39
-	225	((428/901).CCL\$. and warp\$	USPAT	2004/01/14 16:56
-	129603	(print\$ or wiring or circuit) near3 board\$	USPAT	2004/01/14 17:34
-	633	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$)	USPAT	2004/01/15 08:03
-	259	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (single or one) adj (side\$)	USPAT	2004/01/14 16:59
-	7	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) same (warp\$)	USPAT	2004/01/14 17:11
-	15	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (single or one) adj (side\$) and warp\$	USPAT	2004/01/14 17:24
-	11	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (single or one) adj (side\$) and curl\$	USPAT	2004/01/14 17:24
-	8	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (single or one) adj (side\$) and curl\$ not (((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (single or one) adj (side\$) and warp\$)	USPAT	2004/01/14 17:24
-	232155	(print\$ or wiring or circuit) near3 board\$	EPO; JPO; DERNMENT	2004/01/14 17:34
-	602	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$)	EPO; JPO; DERNMENT	2004/01/14 17:35
-	14	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) and (curl\$ or warp\$)	EPO; JPO; DERNMENT	2004/01/14 17:35

-	7	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) same warp\$	USPAT	2004/01/15 10:10
-	6	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$) same curl\$	USPAT	2004/01/15 08:16
-	1	6515355.pn. and warp\$	USPAT	2004/01/15 08:36
-	1	6641898.pn. and warp\$	USPAT	2004/01/15 08:36
-	1	6641898.pn. and warp\$	USPAT	2004/01/15 08:38
-	1	6641898.pn. and cover adj lay\$	USPAT	2004/01/15 08:39
-	633	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$)	USPAT	2004/01/15 09:40
-	29	((print\$ or wiring or circuit) near3 board\$) and (cover adj lay\$)) and (phenol\$ same (kraft or cellulose or paper\$))	USPAT	2004/01/15 09:52
-	0	linter adj paper adj glass adj cloth adj glass adj paper	EPO; JPO; DERMENT	2004/01/15 09:53
-	0	linter adj paper adj glass adj cloth near3 glass adj paper	EPO; JPO; DERMENT	2004/01/15 09:53
-	661	heat adj shrinkage adj factor	EPO; JPO; DERMENT	2004/01/15 09:54
-	2	(heat adj shrinkage adj factor) and printed adj wiring adj board	EPO; JPO; DERMENT	2004/01/15 09:54
-	279	((print\$ or wiring or circuit) near3 board\$) and ((\$resist or \$resists) adj ink)	USPAT	2004/01/15 10:13
-	4	((print\$ or wiring or circuit) near3 board\$) and ((\$resist or \$resists) adj ink) same (warp\$ or curv\$ or cone)	USPAT	2004/01/15 10:37
-	1	(6515356.pn. and warp\$) and (single or one) adj side\$	USPAT	2004/01/15 10:15
-	90	((print\$ or wiring or circuit) near3 board\$) and ((\$resist or \$resists) adj ink) and (single or one) adj side\$	USPAT	2004/01/15 10:38
-	548	((print\$ or wiring or circuit) near3 board\$) and ((\$resist or \$resists) same (warp\$ or curv\$ or cone)	USPAT	2004/01/15 10:37
-	236	((print\$ or wiring or circuit) near3 board\$) and ((\$resist or \$resists) same (warp\$ or curv\$ or cone) and (single or one) adj side\$	USPAT	2004/01/15 10:43